

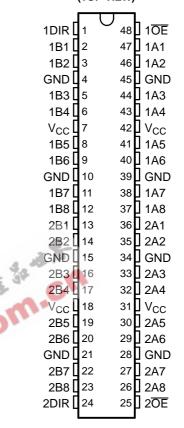
SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS300F-MARCH 1994-REVISED JULY 2005

FEATURES

- Members of the Texas Instruments Widebus™ Family
- State-of-the-Art EPIC-IIB™ BiCMOS Design Significantly Reduces Power Dissipation
- Typical V_{OLP} (Output Ground Bounce) <1 V at V_{CC} = 5 V, T_A = 25°C
- High-Impedance State During Power Up and Power Down
- Distributed V_{CC} and GND Pin Configuration Minimizes High-Speed Switching Noise
- Flow-Through Architecture Optimizes PCB Lavout
- High-Drive Outputs (–32-mA I_{OH}, 64-mA I_{OL})
- Latch-Up Performance Exceeds 500 mA Per JESD 70
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Includes Plastic Thin Very Small-Outline (DGV), Shrink Small-Outline (DL), and Thin Shrink Small-Outline (DGG) Packages and 380-mil Fine-Pitch Ceramic (WD) Flat Package Using 25-mil Center-to-Center Spacings

SN54ABT16245A...WD PACKAGE SN74ABT16245A...DGG, DGV, OR DL PACKAGE (TOP VIEW)



DESCRIPTION

The 'ABT16245A devices are 16-bit noninverting 3-state transceivers designed for synchronous two-way communication between data buses. The control-function implementation minimizes external timing requirements.

These devices can be used as two 8-bit transceviers or one 16-bit transceiver. They allow data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so that the buses are effectively isolated.

When V_{CC} is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impendance state above 2.1 V, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN54ABT16245A is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ABT16245A is characterized for operation from -40°C to 85°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

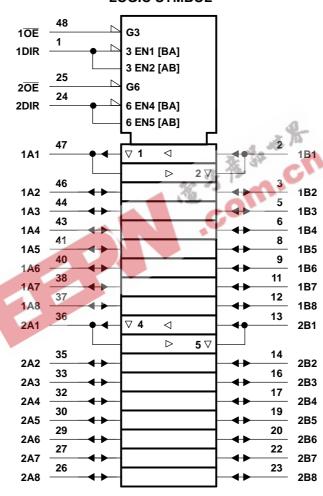
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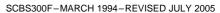
FUNCTION TABLE (EACH 8-BIT SECTION)

INP	UTS	OPERATION
ŌĒ	DIR	OPERATION
L	L	B data to A bus
L	Н	A data to B bus
Н	Χ	Isolation

LOGIC SYMBOL(1)

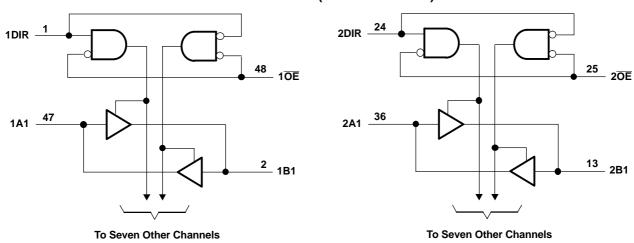


(1) This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.





LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

		200			
		20 3	MIN	MAX	UNIT
V_{CC}	Supply voltage range	132	-0.5	7	V
V_{I}	Input voltage range (except I/O ports) ⁽²⁾	Co.	-0.5	7	V
Vo	Voltage range applied to any output in the high or power	off state	-0.5	5.5	V
I _O	Current into any output in the law state	SN54ABT16245A		96	A
	Current into any output in the low state	SN74ABT16245A		128	mA
I _{IK}	Input clamp current	V _I < 0		-18	mA
I_{OK}	Output clamp current	V _O < 0		-50	mΑ
		DGG package		89	
θ_{JA}	Package thermal impedance (3)	DGV package		93	°C/W
		DL package		94	
T _{stg}	Storage temperature range	-65	150	°C	

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

⁽³⁾ The package thermal impedance is calculated in accordance with JESD 51.

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Recommended Operating Conditions⁽¹⁾

			SN54ABT1	16245A	SN74ABT	UNIT	
			MIN	MAX	MIN	MAX	UNIT
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage		0.8		8.0	V	
V_{I}	Input voltage	0	V_{CC}	0	V_{CC}	V	
I _{OH}	High-level output current			-24		-32	mA
I _{OL}	Low-level output current			48		64	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10		10	ns/V
$\Delta t/\Delta V_{CC}$	Power-up ramp rate				200		μs/V
T _A	Operating free-air temperature	-55	125	-40	85	°C	

⁽¹⁾ All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.





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Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS			T _A = 25°C		SN54ABT16245A		SN74ABT16245A		UNIT	
		TEST CC	TEST CONDITIONS			MIN TYP ⁽¹⁾ MAX			MIN	MAX	UNII	
V _{IK}		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	8	-1.2		-1.2	V	
		$V_{CC} = 4.5 \text{ V}, \qquad I_{OH} = -3 \text{ mA}$		2.5			2.5		2.5			
V		$V_{CC} = 5 V$,	$I_{OH} = -3 \text{ mA}$	3			3		3		V	
V_{OH}		V _{CC} = 4.5 V	I _{OH} = -24 mA	2			2				V	
		V _{CC} = 4.5 V	$I_{OH} = -32 \text{ mA}$	2(2)					2			
V		V _{CC} = 4.5 V	I _{OL} = 48 mA			0.55		0.55			V	
V_{OL}		V _{CC} = 4.5 V	I _{OL} = 64 mA			0.55(2)				0.55	V	
V _{hys}					100						mV	
	Control inputs	$V_{CC} = 0 \text{ to } 5.5 \text{ V}, V_{I} = V_{CC}$	/ _{CC} or GND			±1		±1		±1	μА	
I _I	A or B $V_{CC} = 2.1 \text{ V to } 5.5 \text{ V}, \text{ V}_{I}$		I = V _{CC} or GND	±20 ⁽²⁾			±100	±100		μА		
I _{OZPU}		$V_{CC} = 0 \text{ to } 2.1 \text{ V, } V_{O} =$			±50 ⁽³⁾	4	±50 ⁽³⁾		±50	μΑ		
I_{OZPD}	$V_{CC} = 2.1 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 2.7 \text{ V}, \overline{OE} = X$				±50 ⁽³⁾	75	±50 ⁽³⁾		±50	μΑ		
I _{OZH} ⁽⁴⁾		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V, V}$	$_{O}$ = 2.7 V, \overline{OE} \geq 2 V		25.	10(5)	-	10		10 ⁽⁵⁾	μΑ	
$I_{OZL}^{(4)}$		$V_{CC} = 2.1 \text{ V to } 5.5 \text{ V, V}$	$I_{O} = 0.5 \text{ V}, \text{ OE} \ge 2 \text{ V}$		几門	-10 ⁽⁵⁾	CI	-10		-10 ⁽⁵⁾	μΑ	
I _{off}		$V_{CC} = 0$,	V_I or $V_O \le 5.5 \text{ V}$	36	J.	±100				±100	μΑ	
I _{CEX}		$V_{CC} = 5.5 \text{ V},$ $V_{O} = 5.5 \text{ V}$	Outputs high	1.30	CO	50		50		50	μΑ	
I _O ⁽⁶⁾		$V_{CC} = 5.5 V,$	$V_0 = 2.5 \text{ V}$	-50	-100	-180	-50	-180	-50	-180	mA	
		.,	Outputs high			2		2		2		
I_{CC}	A or B	$V_{CC} = 5.5 \text{ V}, I_O = 0,$ $V_I = V_{CC} \text{ or GND}$	Outputs low			32		32		32	mA	
	port	1 100 11 111	Outputs disabled			2		2		2		
	5 .	$V_{CC} = 5.5 \text{ V},$	Outputs enabled			2		1.5		2		
$\Delta I_{CC}^{(7)}$	Data inputs	One inputs at 3.4 V, Other inputs at V _{CC} or GND	Outputs disabled			0.05		1		0.05	mA	
	Control inputs	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND				1.5		1.5		1.5		
C _i	Control inputs	V _I = 2.5 V or 0.5 V			3						pF	
Co	A or B port	V _O = 2.5 V or 0.5 V			6						pF	

- All typical values are at V_{CC} = 5 V.
 On products compliant to MIL-PRF-38535, this parameter does not apply.
 On products compliant to MIL-PRF-38535, this parameter is not production tested.

- The parameters I_{OZH} and I_{OZL} include the input leakage current.

 This limit may vary among suppliers.

 Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
- This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

SN54ABT16245A, SN74ABT16245A 16-BIT BUS TRANSCEIVERS WITH 3-STATE OUTPUTS





Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C	_{CC} = 5 V, \(= 25°C		MIN	MAX	UNIT
			MIN	TYP	MAX			
t _{PLH}	A or B	B or A	0.5	2.2	3.4	0.5	4	ns
t _{PHL}	AOIB	BULK	0.5	2.3	3.8	0.5	4.6	115
t _{PZH}	OE	B or A	0.8	3.6	5.2	0.8	5.5	ns
t _{PZL}	OL	BULK	0.9	3.7	6.1	0.1	7.3	115
t _{PHZ}	OE	B or A	1.3	4.4	5.8	1.3	6.3	nc
t _{PLZ}	OE .	D OI A	1.4	3.3	4.7	1.4	5.5	ns

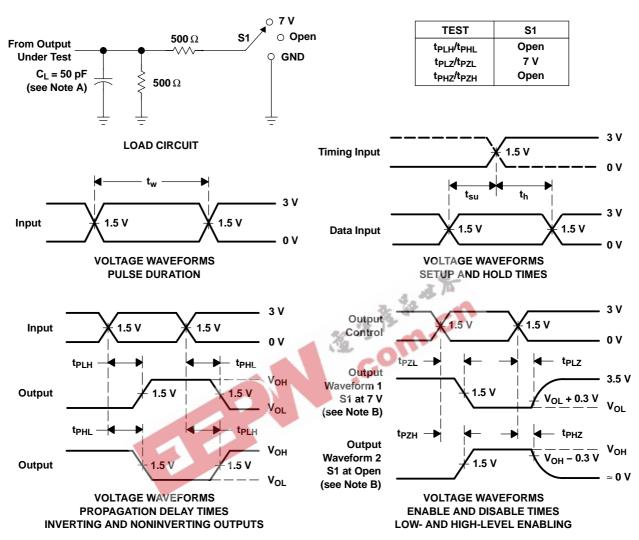
Switching Characteristics

over recommended operating ranges of supply voltage and operating free-air temperature, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

		SN74ABT16245A							
PARAMETER	FROM (INPUT)		TO (OUTPUT)	V _C	_{CC} = 5 V _A = 25°C	•	MIN	MAX	UNIT
			4 32	MIN	TYP	MAX			
t _{PLH}	A or B		B or A	1	2.2	3.4	1	3.9	nc
t _{PHL}	AOIB		BOLA	1	2.3	3.7	1	4.2	ns
t _{PZH}	ŌĒ		B or A	1	3.6	5.2	1	6.3	no
t _{PZL}	OE		D UI A	1	3.7	5.4	1	6.4	ns
t _{PHZ}	<u>OE</u>		B or A	2	4.4	5.8	2	6.3	nc
t _{PLZ}	OE OE		BUIA	1.5	3.3	4.7	1.5	5.2	ns



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_{O} = 50 Ω , $t_{f} \leq$ 2.5 ns, $t_{f} \leq$ 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

26-Sep-2005

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9317501MXA	ACTIVE	CFP	WD	48	1	TBD	Call TI	Level-NC-NC-NC
74ABT16245ADGGRG4	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
74ABT16245ADGVRE4	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADGGR	ACTIVE	TSSOP	DGG	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADGVR	ACTIVE	TVSOP	DGV	48	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADL	ACTIVE	SSOP	DL	48	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADLR	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ABT16245ADLRG4	ACTIVE	SSOP	DL	48	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SNJ54ABT16245AWD	ACTIVE	CFP	WD	48	1,38	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

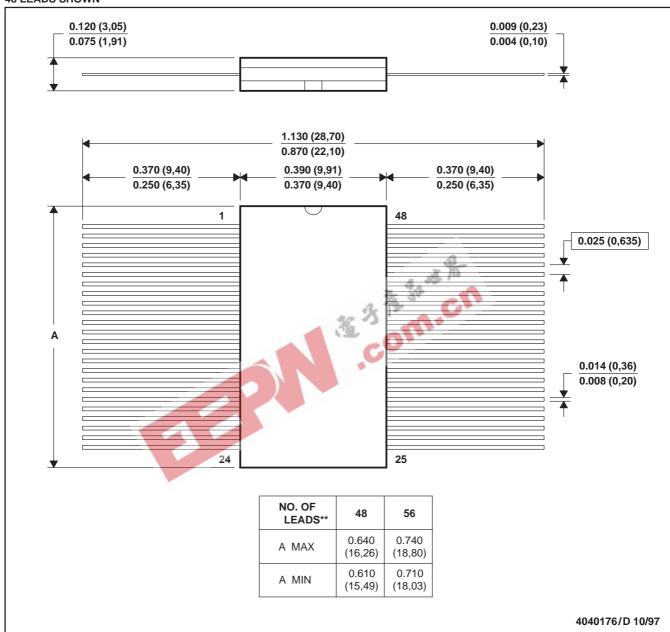
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WD (R-GDFP-F**)

CERAMIC DUAL FLATPACK

48 LEADS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only
- E. Falls within MIL STD 1835: GDFP1-F48 and JEDEC MO-146AA

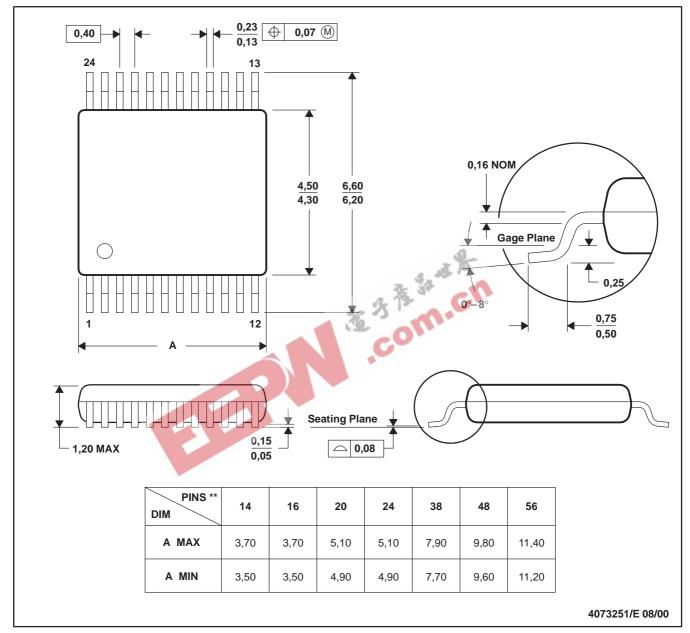
GDFP1-F56 and JEDEC MO-146AB



DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

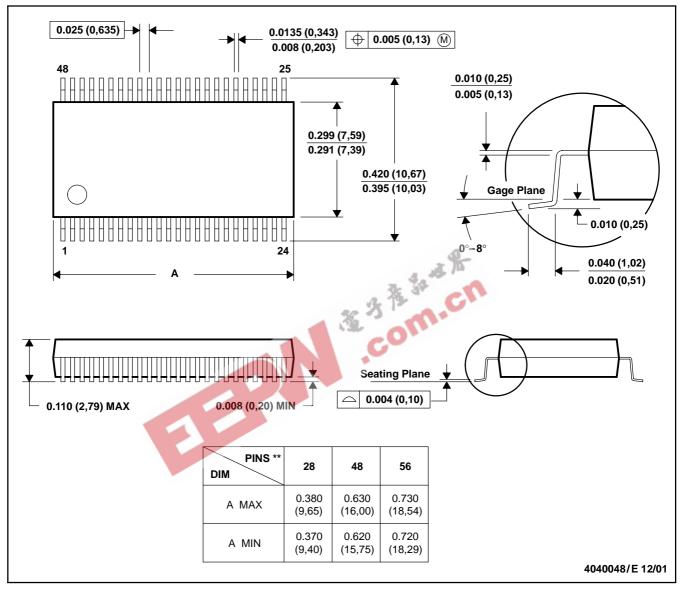
D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



DL (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



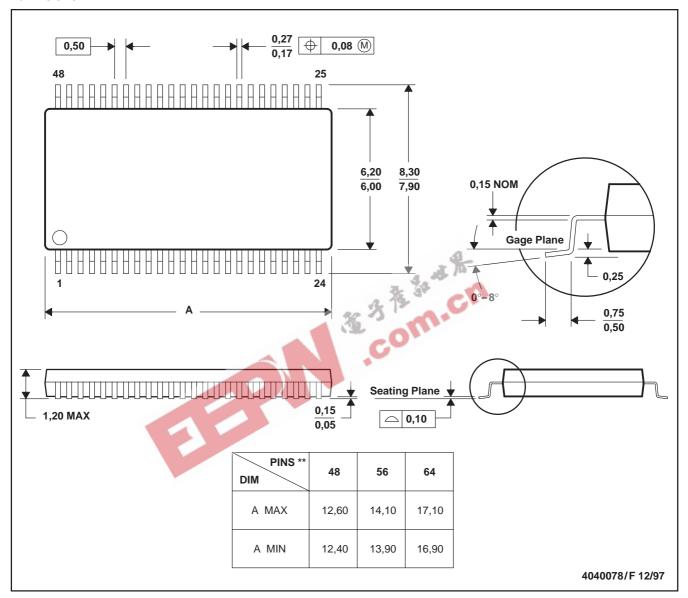
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MO-118

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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